SCOPE :

This specification applies to the Pb Free high current type SMD inductors for MSCDRI-5D28-SERIES

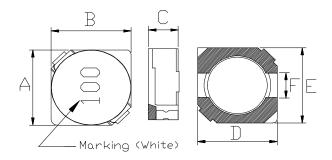
PRODUCT INDENTIFICATION

<u>MSCDRI</u> - <u>5D28</u> - <u>100</u> <u>M</u>



- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- **④** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 5.70±0.3	mm
B: 5.70±0.3	mm
C: 3.00 Max.	mm
D: 5.50 Typ.	mm
Е: 5.50 Тур.	mm
F: 2.00 Typ.	mm

(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1 TEST INSTRUMENTS

- IEST INSTRUMENTS
- L : HP 4284A PRECISION LCR METER (or equivalent)
- RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60 $^\circ\!\!\! C$ Max.
- (3)-2 Operate temperature range $-40^{\circ}C \sim +125^{\circ}C$ (Including self temp. rise)
- (3)-3 Storage temperature range $-40^{\circ}C \sim +125^{\circ}C$



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current	Morking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC(A)	Marking
MSCDRI-5D28-1R0	1.0	Ν	100kHz/0.25V	12m	3.70	1R0
MSCDRI-5D28-1R2	1.2	Ν	100kHz/0.25V	13m	3.50	1R2
MSCDRI-5D28-2R2	2.2	Ν	100kHz/0.25V	18m	2.80	2R2
MSCDRI-5D28-2R5	2.5	Ν	100kHz/0.25V	18m	2.60	2R5
MSCDRI-5D28-2R7	2.7	Ν	100kHz/0.25V	18m	2.60	2R7
MSCDRI-5D28-3R0	3.0	Ν	100kHz/0.25V	24m	2.40	3R0
MSCDRI-5D28-3R3	3.3	M,N	100kHz/0.25V	24m	2.40	3R3
MSCDRI-5D28-3R9	3.9	N	100kHz/0.25V	31m	2.20	3R9
MSCDRI-5D28-4R2	4.2	Ν	100kHz/0.25V	31m	2.20	4R2
MSCDRI-5D28-4R7	4.7	M,N	100kHz/0.25V	35m	2.00	4R7
MSCDRI-5D28-5R3	5.3	N	100kHz/0.25V	38m	1.90	5R3
MSCDRI-5D28-6R2	6.2	N	100kHz/0.25V	45m	1.80	6R2
MSCDRI-5D28-6R6	6.6	M,N	100kHz/0.25V	45m	1.80	6R6
MSCDRI-5D28-8R2	8.2	M,N	100kHz/0.25V	53m	1.60	8R2
MSCDRI-5D28-100	10	M,N	100kHz/0.25V	65m	1.30	100
MSCDRI-5D28-120	12	M,N	100kHz/0.25V	76m	1.20	120
MSCDRI-5D28-150	15	M,N	100kHz/0.25V	0.103	1.10	150
MSCDRI-5D28-180	18	M,N	100kHz/0.25V	0.110	1.00	180
MSCDRI-5D28-220	22	M,N	100kHz/0.25V	0.122	0.90	220
MSCDRI-5D28-270	27	M,N	100kHz/0.25V	0.175	0.85	270
MSCDRI-5D28-330	33	M,N	100kHz/0.25V	0.189	0.75	330
MSCDRI-5D28-390	39	M,N	100kHz/0.25V	0.212	0.70	390
MSCDRI-5D28-470	47	M,N	100kHz/0.25V	0.250	0.62	470
MSCDRI-5D28-560	56	M,N	100kHz/0.25V	0.305	0.58	560
MSCDRI-5D28-680	68	M,N	100kHz/0.25V	0.355	0.52	680
MSCDRI-5D28-820	82	M,N	100kHz/0.25V	0.463	0.46	820
MSCDRI-5D28-101	100	M,N	100kHz/0.25V	0.520	0.42	101
MSCDRI-5D28-151	150	M,N	100kHz/0.25V	1.050	0.35	151
MSCDRI-5D28-181	180	M,N	100kHz/0.25V	1.550	0.32	181

%
specify the inductance tolerance,M(±20%),N(±30%)

% IDC : Based on inductance change (△L/Lo : \leq drop 35%) @ambient temp. 25°C and Based on temperature rise (△T : 40°C TYP.)



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.				
		R5 45±2 45±2 1 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
Concertability	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130 \sim 150 $^\circ\!\mathrm{C}$ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			



MECHANICAL

cor The	Temperature profile of reflow soldering $300 \xrightarrow{90}{90} \xrightarrow{90}{90} \xrightarrow{90}{90}$ (Peak temperature 2001:3° 10 sec $300 \xrightarrow{90}{90} \xrightarrow{90}{90}$
	oblems. Th col Th

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20℃ ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be $\triangle L/L20^{\circ}C \leq \pm 10\%$.



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The san	nple s	hall be left for 96±4 hou	rs in an atmospere with	<u></u> ו	
storage		a tempe	a temperature of 85±2 $^\circ\!\!{ m C}$ and a normal humidity.				
	There shall be	Upon co	Upon completion of the measurement shall be made after the				
	no mechanical	sample	sample has been left in a normal temperature and normal				
	damage.	humidit	humidity for 1 hour.				
Low temperature	∆L/Lo≦±5%	The san	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a tempe	rature	e of -25±3℃.			
	There shall be	Upon co	omple	ion of the test, the mea	surement shall be mad	е	
	no mechanical	after the	e sam	ole has been left in a no	rmal temperature and		
	damage.	normal	humid	ity for 1 hour.			
Change of	∆L/Lo≦±5%	The san	nple s	hall be subject to 5 cont	tinuos cycles, such as s	shown	
temperature		in the ta	ble 2	below and then it shall b	be subjected to standa	rd	
	There shall be	atmosp	heric (conditions for 1 hour, af	ter which measuremen	t	
	no other dama-	shall be	made				
	ge of problems						
				table 2			
				Temperature	Duration		
			1	− 25±3° C	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	85±2℃	30 min.		
				(Themostat No.2)			
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The san	nple s	hall be left for 96±4 hou	rs in a temperature of		
		$40\pm2^{\circ}$ and a humidity(RH) of 90 \sim 95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the	after the sample has been left in a normal temperature and				
	damage.	normal humidity more than 1 hour.					
Test conditions :		1					
The	sample shall be reflow	w soldered	l onto	the printed circuit boar	d in every test.		

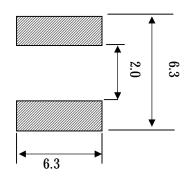


(5) LAND DIMENSION (Ref.)

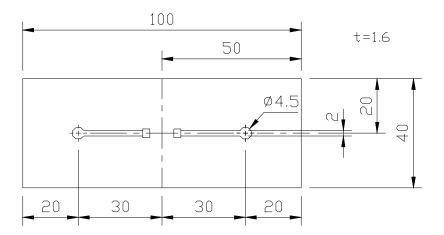
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit : mm

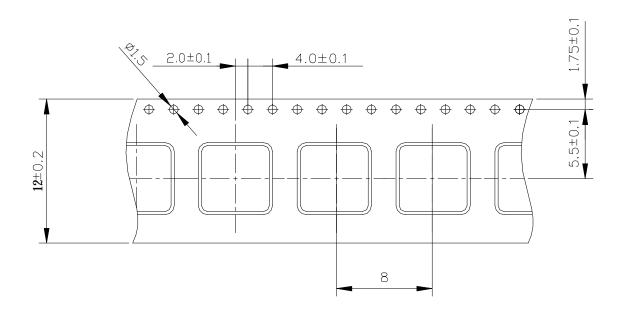


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



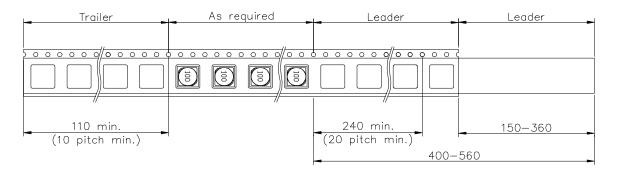


(6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)



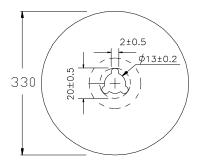
(6)-2 TAPING DIMENSIONS (mm)

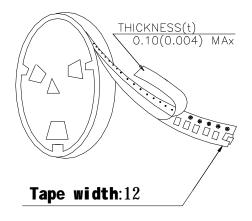






(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

2000pcs/Reel

The products are packaged so that no damage will be sustained.

